GSDSS3D2F Series**

Schottky Barrier Diode

Product Description

Reverse Voltage 40V to 200V. Forward Current 3.0A

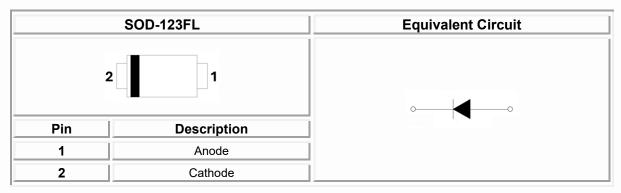
Features

- Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- RoHS Compliant and Halogen Free

Mechanical Data

- Case: Molded Plastic, SOD-123FL Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color Band denotes Cathode End

Package and Pin Assignment



Ordering and Marking Information

Ordering Information			
Part Number Package Marking Code Quantity/Re		Quantity/Reel	
GSDSS34D2F	SOD-123FL	K34	3000 PCS
GSDSS36D2F	SOD-123FL	K36	3000 PCS
GSDSS315D2F	SOD-123FL	K315	3000 PCS
GSDSS320D2F	SOD-123FL	K320	3000 PCS

GSDSS3 1 1 D2 F

- **Product Code:** GSDSS3
- Voltage Code:
 - 1 1 is 4, 6, 15 and 20.
 - For examples 4 stands for 40V and 20 stands for 200V

- Green Level:
 - **F** for RoHS Compliant and Halogen Free

- Package Code:

D2 for SOD-123FL Package



Marking Information

K3 1 1

- Product Code:

K3

- Voltage Code:

1 is 4, 6, 15 and 20.

For examples 4 stands for 40V

and 20 stands for 200V

Electrical Characteristics (Ratings at 25°C Ambient Temperature Unless Otherwise Specified.)

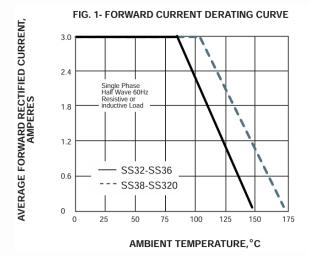
Symbol	Conditions		34	36	315	320	Unit
V_{RRM}	Maximum Recurrent Peak Reverse Voltage		40	60	150	200	V
V _{RMS}	Maximum RMS Voltage		28	42	105	140	V
V _{DC}	Maximum DC Blocking Voltage		40	60	150	200	V
I _{F(AV)}	Maximum Average Forward Rectified Current		3.0				А
Ігѕм	Peak Forwa Current (8.3 Half Sine-W	ms Single		80			А
VF	Maximum Forward Voltage at 3.0A (Note1)		0.55	0.7	0.85	0.95	V
	Maximum Reverse I _R Leakage Current at rated V _R	T _A = 25°C	0.5				
I _R		T _A = 100°C	20		10		mA
Сл	Typical Junction Capacitance ⁽¹⁾		500		300		pF
$R_{\theta JA}$	Typical Thermal Resistance ⁽²⁾		88				°C/W
Тл	Operating Junction Temperature Range		-65 to +150				°C
Тѕтс	Storage Temperature Range			-65 to +150			°C

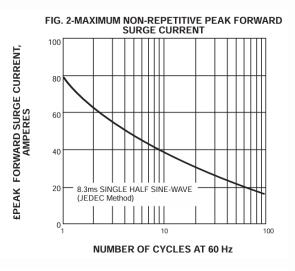
NOTES:

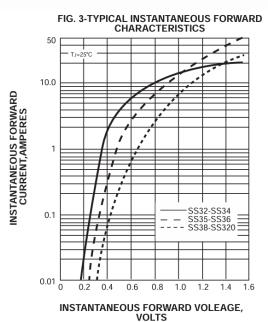
- 1. Measured at 1MHz and applied reverse voltage of 4.0 V_{DC} . 2. Mounted with 0.2 x 0.2" (5.0 x 5.0mm) Copper Pad Areas

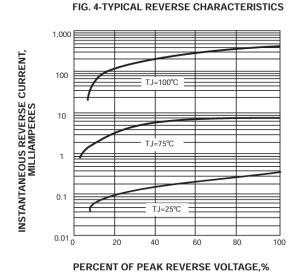


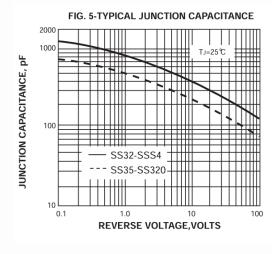
Typical Characteristics (Ratings at 25°C Ambient Temperature Unless Otherwise Specified.)

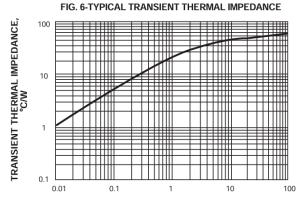












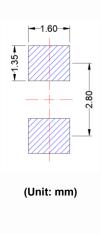
 $t, \hbox{\tt PULSE DURATION}, \hbox{\tt sec}.$

SOD-123FL

Package Dimension

BACKSIDE VIEW

Recommended Land Pattern



	Dimensions			
SYMBOL	Millimeters		Inches	
	MIN	MAX	MIN	MAX
Α	0.80	1.10	0.031	0.043
b	0.50	1.20	0.020	0.047
D	1.50	1.90	0.059	0.075
E	3.30	3.80	0.130	0.150
E1	2.45	2.75	0.096	0.108
С	0.05	0.20	0.002	0.008
L	0.70	0.90	0.028	0.035

NOTE:

DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



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